

ON Semiconductor®

FQT3P20 P-Channel QFET[®] MOSFET

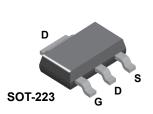
-200 V, -0.67 A, 2.7 Ω

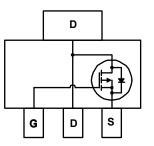
Description

This P-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 0.67 A, -200 V, ${\rm R}_{\rm DS(on)}$ = 2.7 Ω (Max.) $@\,{\rm V}_{\rm GS}$ = 10 V, ${\rm I}_{\rm D}$ = 0.335 A
- Low Gate Charge (Typ. 6.0 nC)
- Low Crss (Typ. 7.5 pF)





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

Symbol	Parameter	FQT3P20TF	Unit	
V _{DSS}	Drain-Source Voltage	-200	V	
I _D	Drain Current - Continuous (T _C = 25	-0.67	А	
	- Continuous (T _C = 70	°C)	-0.53	A
DM	Drain Current - Pulsed	(Note 1)	-2.7	A
V _{GSS}	Gate-Source Voltage	± 30	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	150	mJ
AR	Avalanche Current	(Note 1)	-0.67	A mJ
E _{AR}	Repetitive Avalanche Energy	(Note 1)	0.25	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-5.5	V/ns
PD	Power Dissipation ($T_C = 25^{\circ}C$)		2.5	W
	- Derate above 25°C	0.02	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
Τ _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

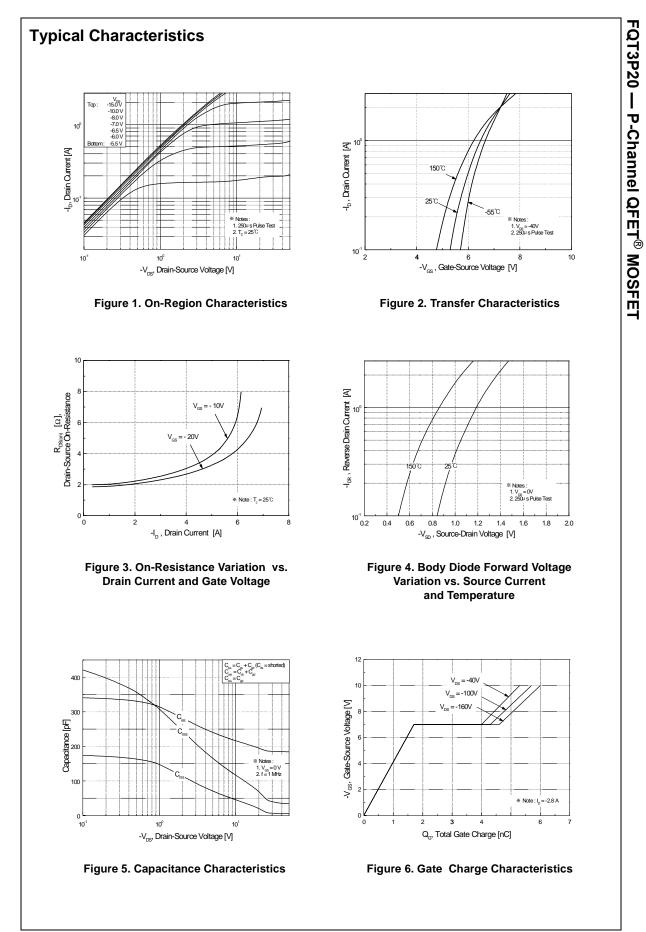
Thermal Characteristics

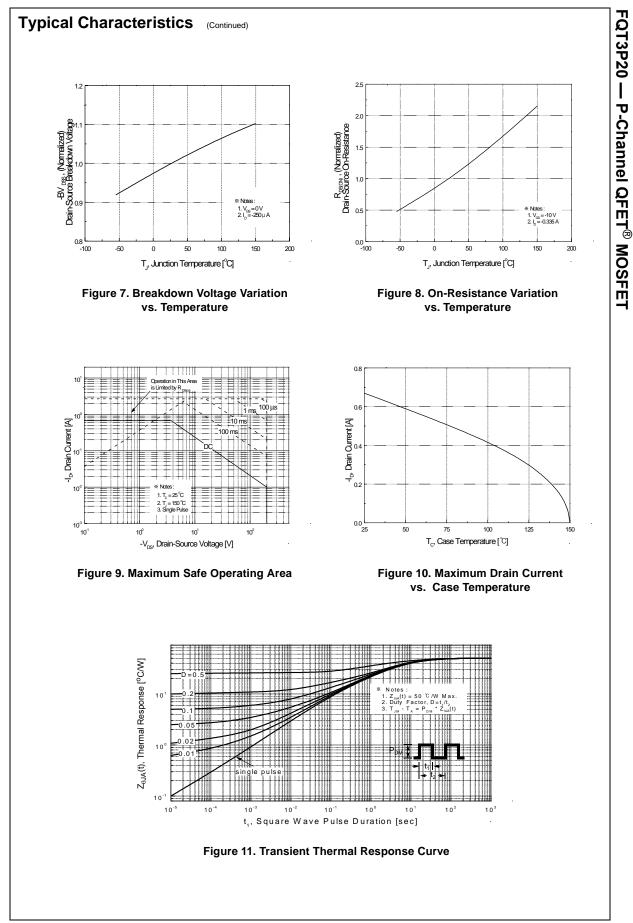
Symbol	Parameter	FQT3P20TF	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	50	°C/W

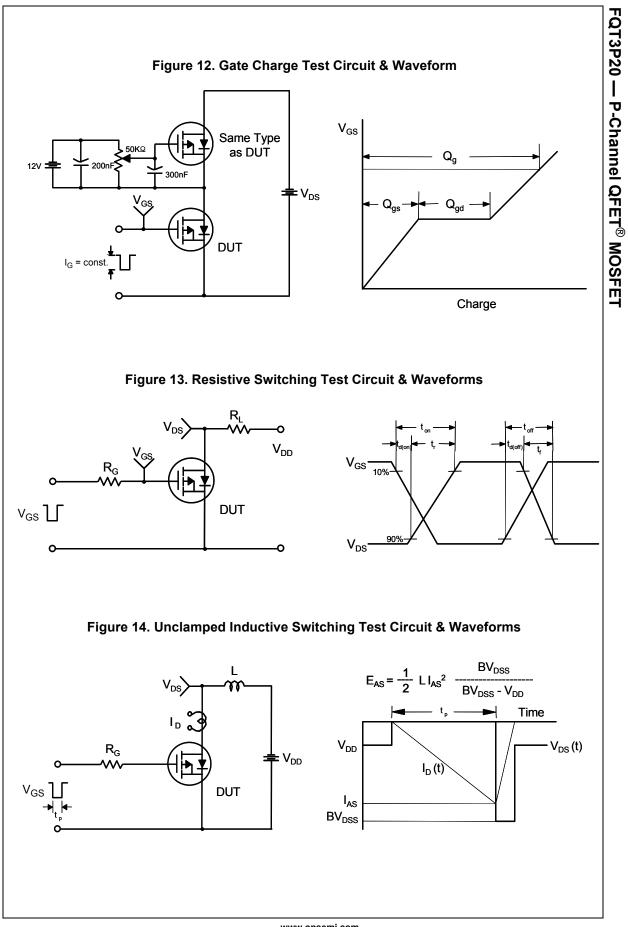
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Device Marking FQT3P20		ng Device I		Package Reel Size 1		Tape Width		Quantity	
		FQT3P20TF	SOT-223	OT-223 13"		12 mm		2500 units	
lectri	cal Cha	racteristics T _c	25°C unless other	nuine noted	H				
Symbol		Parameter	= 25°C unless other	Test Conditions		Min	Тур	Max	Unit
04 Ok -									
BV _{DSS}	Drain-Sou	Irce Breakdown Voltage	$V_{00} = 0$	V In = -250 µA		-200			V
ΔB _{VDSS} /		5	vgs = 0	V _{GS} = 0 V, I _D = -250 μA		-200			v
ΔT _J	Coefficien	n Voltage Temperature It	_	$I_D = -250 \ \mu$ A, Referenced to 25°C			-0.18		V/°C
I _{DSS}	Zero Gate Voltage Drain Current			$V_{DS} = -200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$				-1	μA
-				V _{DS} = -160 V, T _C = 125°C				-10	μA
IGSSF		y Leakage Current, Forw		V_{GS} = -30 V, V_{DS} = 0 V				-100	nA
GSSR	Gate-Bod	y Leakage Current, Reve	rse $V_{GS} = 30$	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
On Cha	racterist	ics							
V _{GS(th)}	Gate Thre	eshold Voltage	$V_{DS} = V_{0}$	_{GS} , I _D = -250 μA		-3.0		-5.0	V
R _{DS(on)}	Static Dra On-Resist	in-Source tance	V _{GS} = -1	0 V, I _D = -0.335 A	L		2.06	2.7	Ω
9 _{FS}	Forward 1	Transconductance	V _{DS} = -4	0 V, I _D = -0.335 A			0.7		S
Dynam	ic Chara	cteristics							
C _{iss}	Input Cap	acitance	V _{DS} = -2	V _{DS} = -25 V, V _{GS} = 0 V, f = 1.0 MHz			190	250	pF
C _{oss}	Output Ca	apacitance	f = 1.0 N				45	60	pF
C _{rss}	Reverse	Fransfer Capacitance					7.5	10	pF
Switchi	ng Chara	acteristics							
t _{d(on)}	Turn-On [Delay Time	V - 1	00 V, I _D = -2.8 A,			8.5	25	ns
t _r	Turn-On F	Rise Time	$R_{G} = 25$				35	80	ns
d(off)	Turn-Off	Delay Time		22			12	35	ns
t _f	Turn-Off F	Fall Time			(Note 4)		25	60	ns
Qg	Total Gate	e Charge	V _{DS} = -1	60 V, I _D = -2.8 A,			6.0	8.0	nC
Q _{gs}	Gate-Sou	rce Charge	V _{GS} = -1	5			1.7		nC
Q _{gd}	Gate-Drai	n Charge			(Note 4)		2.9		nC
Drain-S	ource Di	ode Characteristic	s and Maxi	mum Ratings					
I _S		Continuous Drain-Sourc		•				-0.67	А
I _{SM}		Pulsed Drain-Source Did						-2.7	A
V _{SD}		Irce Diode Forward Volta		V, I _S = -0.67 A				-5.0	V
trr		Recovery Time		V, I _S = -2.8 A,			100		ns
Qrr		Recovery Charge		= 100 A/μs			0.34		μC
L = 500 mH, $I_{SD} \leq -2.8 \text{A}$	$I_{AS} = -0.67A, V$, di/dt $\leq 300A/p$	dth limited by maximum junction f $_{DD} = -50V$, $R_G = 25 \Omega$, Starting T $_{JS}$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 2$ operating temperature	_J = 25°C						

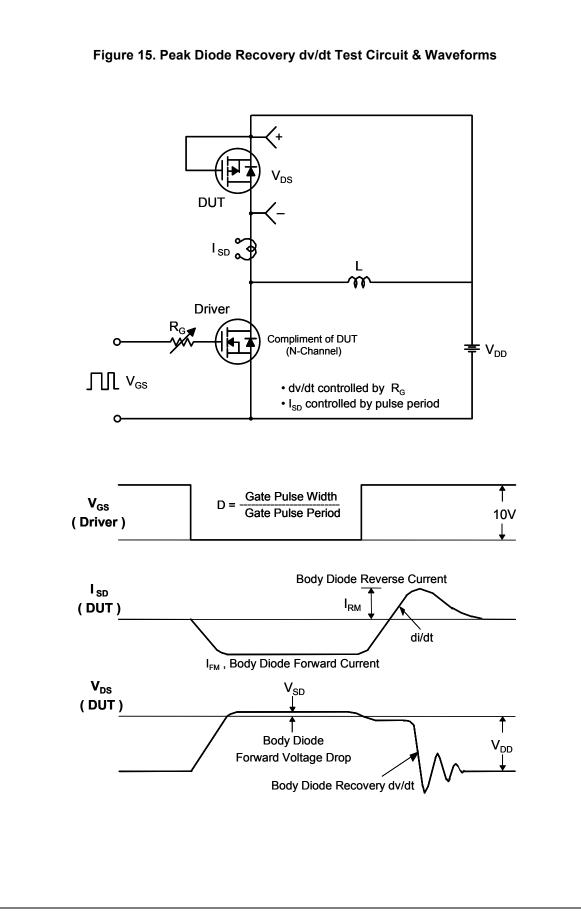
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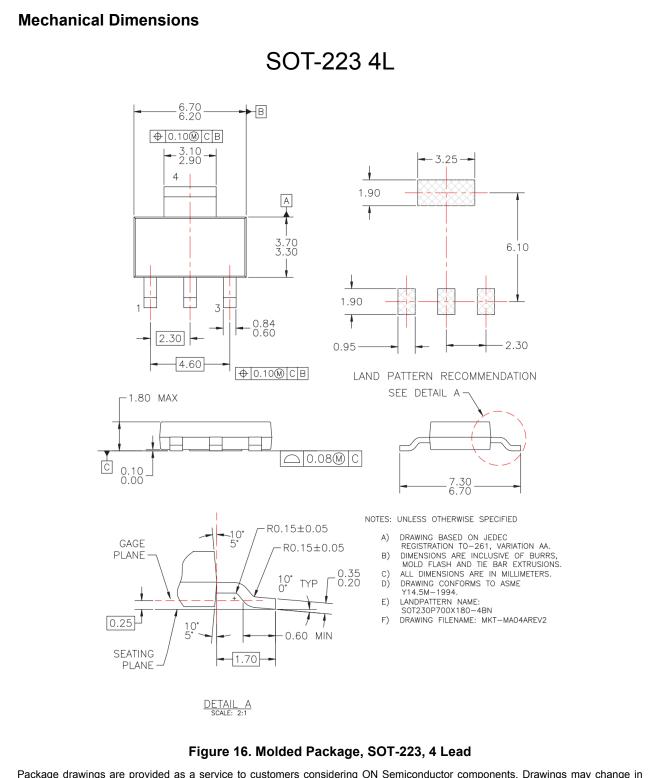




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Dimension in Millimeters

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